



ESD



TVS



MOS



LDO



Diode



Sensor



DC-DC

Product Specification

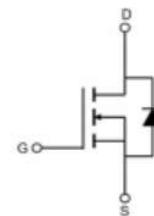
| | |
|--------------------------|---------|
| ▶ Domestic Part Number | IRF7855 |
| ▶ Overseas Part Number | IRF7855 |
| ▶ Equivalent Part Number | IRF7855 |



IRF7855

Feature

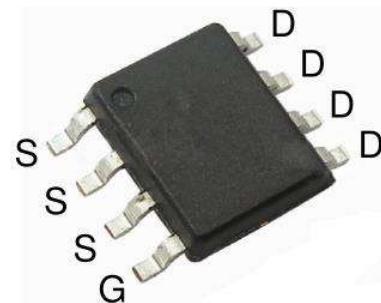
- 60V,12A
- $R_{DS(on)} < 12m\Omega @ V_{GS}=10V$
- $R_{DS(on)} < 17m\Omega @ V_{GS}=4.5V$
- Advanced Trench Technology
- Lead free product is acquired
- Excellent $R_{DS(on)}$ and Low Gate Charge



Schematic Diagram

Application

- PWM applications
- Load Switch
- Power management



SOP-8

ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Value | Unit |
|--|-----------------|----------|--------------|
| Drain-Source Voltage | V_{DS} | 60 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Continuous Drain Current ($T_a = 25^\circ C$) | I_D | 12 | A |
| Continuous Drain Current ($T_a = 100^\circ C$) | I_D | 8 | A |
| Pulsed Drain Current ⁽¹⁾ | I_{DM} | 48 | A |
| Singel Pulsed Avalanche Energy ⁽²⁾ | E_{AS} | 121 | mJ |
| Power Dissipation | P_D | 3.2 | W |
| Thermal Resistance from Junction to Ambient ⁽⁴⁾ | $R_{\theta JA}$ | 39 | $^\circ C/W$ |
| Junction Temperature | T_J | 150 | $^\circ C$ |
| Storage Temperature | T_{STG} | -55~+150 | $^\circ C$ |

MOSFET ELECTRICAL CHARACTERISTICS($T_a=25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Test Condition | Min | Type | Max | Unit |
|---|-----------------------------|---|-----|------|-----------|------------------|
| Static Characteristics | | | | | | |
| Drain-source breakdown voltage | $V_{(\text{BR})\text{DSS}}$ | $V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$ | 60 | - | - | V |
| Zero gate voltage drain current | I_{DSS} | $V_{\text{DS}} = 60\text{V}, V_{\text{GS}} = 0\text{V}$ | - | - | 1 | μA |
| Gate-body leakage current | I_{GSS} | $V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$ | - | - | ± 100 | nA |
| Gate threshold voltage ⁽³⁾ | $V_{\text{GS}(\text{th})}$ | $V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$ | 1 | 1.6 | 2.5 | V |
| Drain-source on-resistance ⁽³⁾ | $R_{\text{DS}(\text{on})}$ | $V_{\text{GS}} = 10\text{V}, I_D = 12\text{A}$ | - | 9.5 | 12 | $\text{m}\Omega$ |
| | | $V_{\text{GS}} = 4.5\text{V}, I_D = 8\text{A}$ | - | 12 | 17 | |
| Dynamic characteristics | | | | | | |
| Input Capacitance | C_{iss} | $V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$ | - | 4605 | - | pF |
| Output Capacitance | C_{oss} | | - | 215 | - | |
| Reverse Transfer Capacitance | C_{rss} | | - | 191 | - | |
| Switching characteristics | | | | | | |
| Turn-on delay time | $t_{\text{d}(\text{on})}$ | $V_{\text{DD}} = 30\text{V}, I_D = 12\text{A}, V_{\text{GS}} = 10\text{V}, R_G = 3\Omega$ | - | 7.1 | - | ns |
| Turn-on rise time | t_r | | - | 5.3 | - | |
| Turn-off delay time | $t_{\text{d}(\text{off})}$ | | - | 27.2 | - | |
| Turn-off fall time | t_f | | - | 6.2 | - | |
| Total Gate Charge | Q_g | $V_{\text{DS}} = 30\text{V}, I_D = 12\text{A}, V_{\text{GS}} = 10\text{V}$ | - | 77 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 9 | - | |
| Gate-Drain Charge | Q_{gd} | | - | 23 | - | |
| Source-Drain Diode characteristics | | | | | | |
| Diode Forward voltage ⁽³⁾ | V_{DS} | $V_{\text{GS}} = 0\text{V}, I_s = 10\text{A}$ | - | - | 1.2 | V |
| Diode Forward current ⁽⁴⁾ | I_s | | - | - | 12 | A |

Notes:

1. Repetitive Rating: pulse width limited by maximum junction temperature
2. EAS Condition: $T_J=25^\circ\text{C}, V_{\text{DD}}=30\text{V}, R_G=25\Omega, L=0.5\text{mH}, I_{\text{AS}}=22\text{A}$
3. Pulse Test: pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
4. Surface Mounted on FR4 Board, $t \leq 10$ sec

Test Circuit

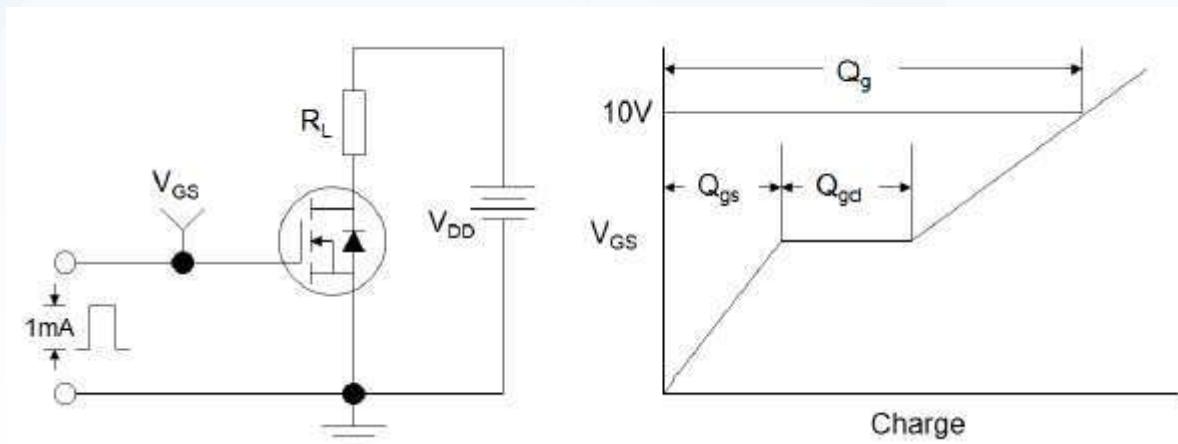


Figure 1: Gate Charge Test Circuit & Waveform

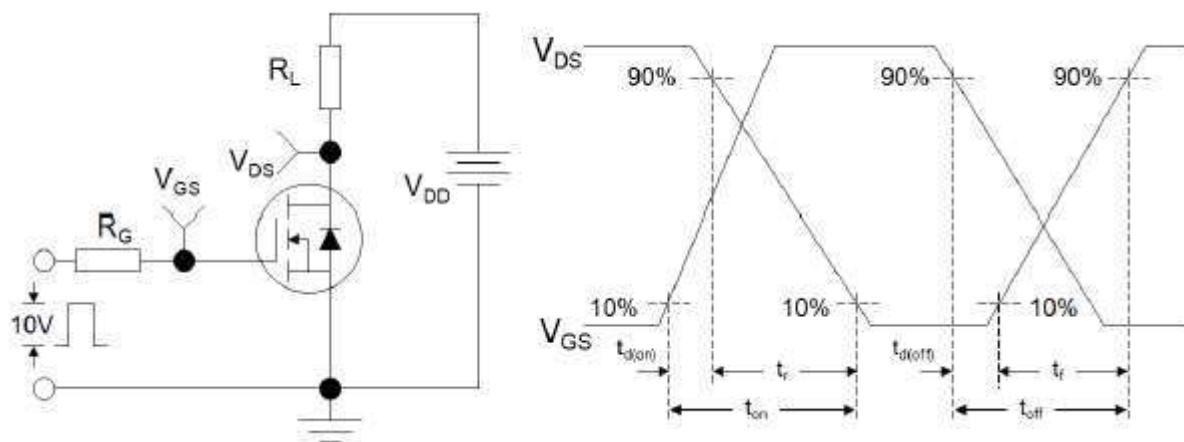


Figure 2: Resistive Switching Test Circuit & Waveforms

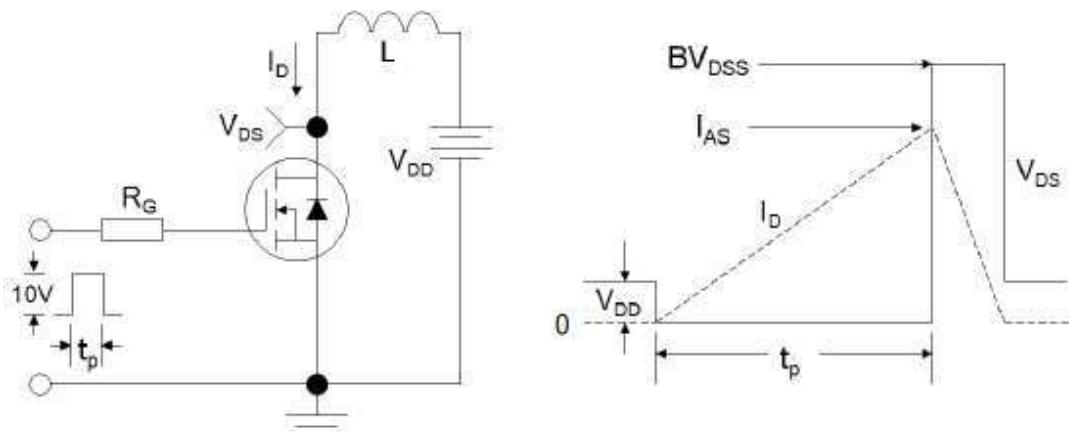


Figure 3: Unclamped Inductive Switching Test Circuit & Waveforms

Typical Performance Characteristics

Figure 1: Output Characteristics

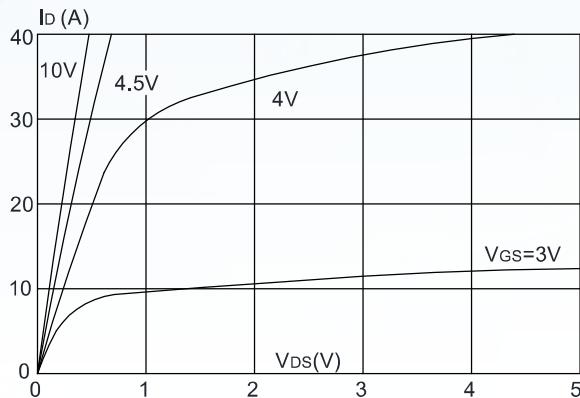


Figure 3: On-resistance vs. Drain Current

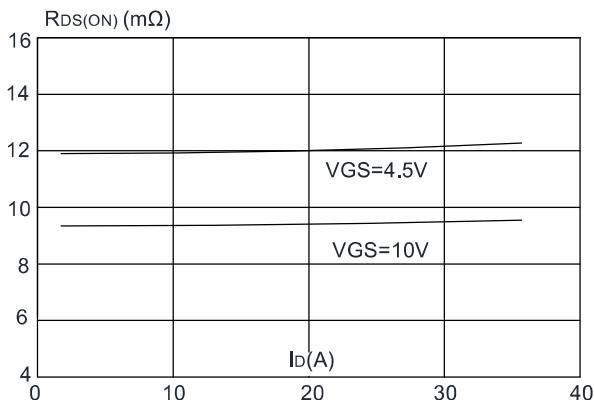


Figure 5: Gate Charge Characteristics

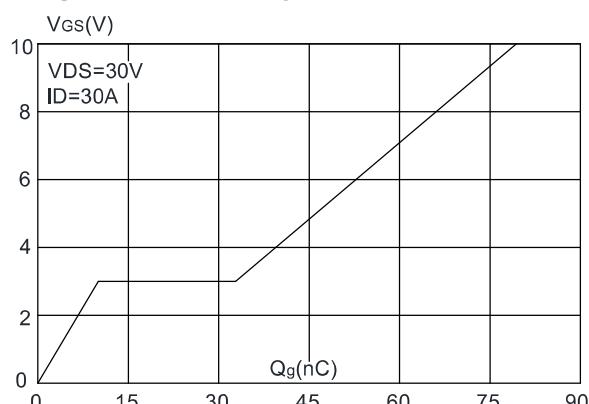


Figure 2: Typical Transfer Characteristics

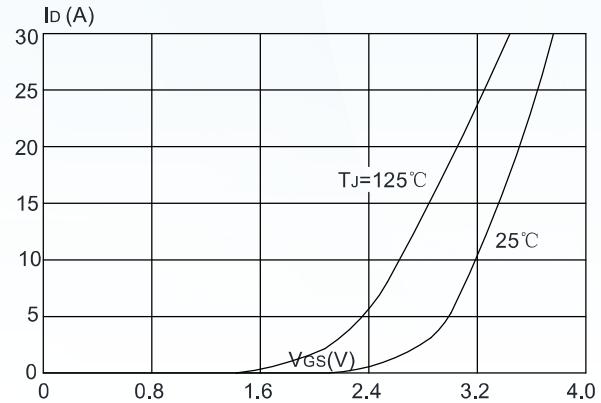


Figure 4: Body Diode Characteristics

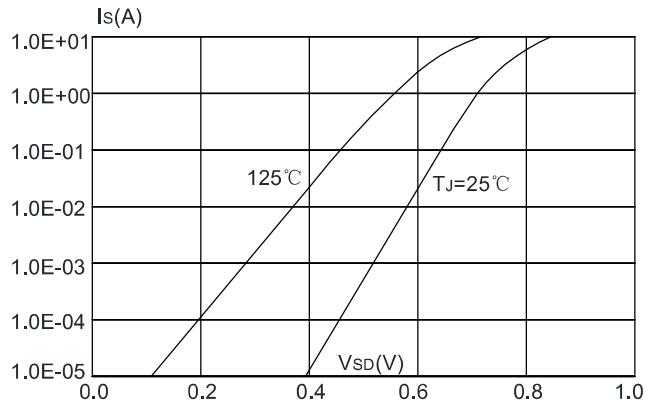


Figure 6: Capacitance Characteristics

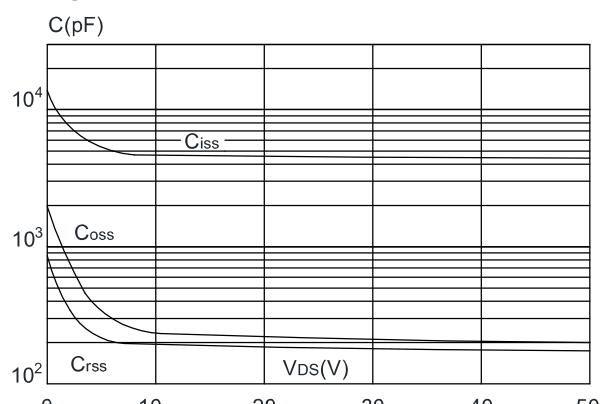


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

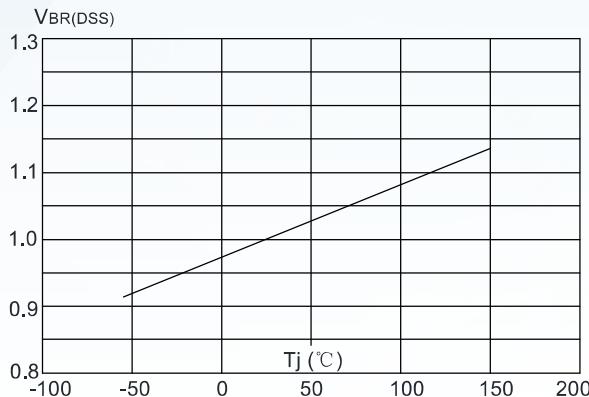


Figure 8: Normalized on Resistance vs. Junction Temperature

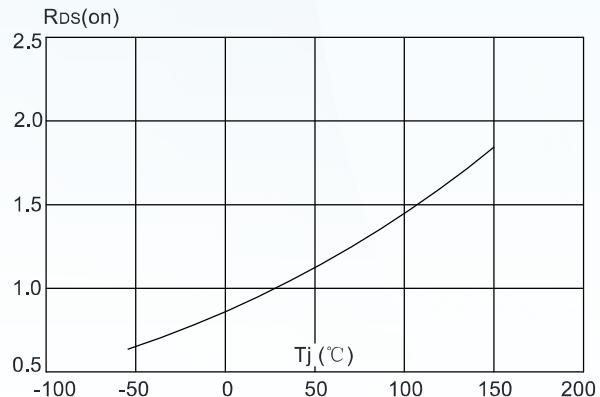


Figure 9: Maximum Safe Operating Area

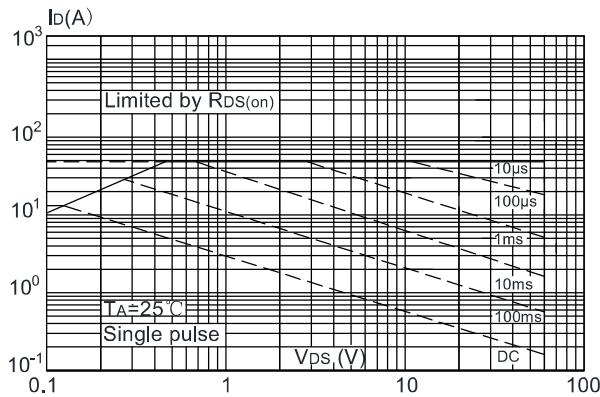


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

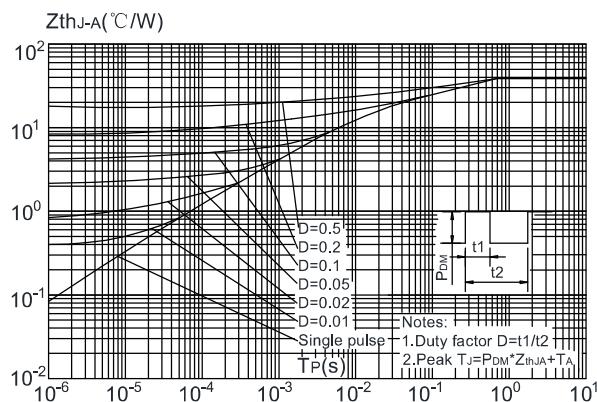
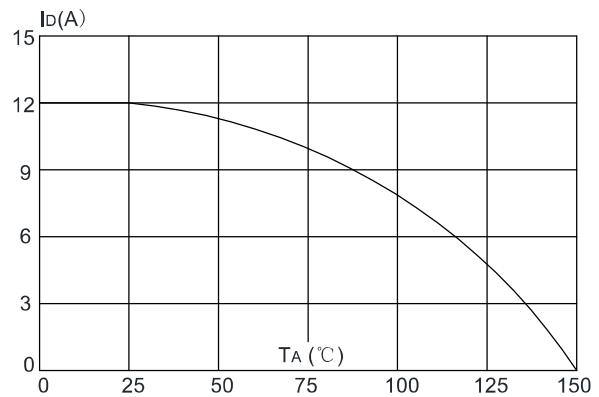
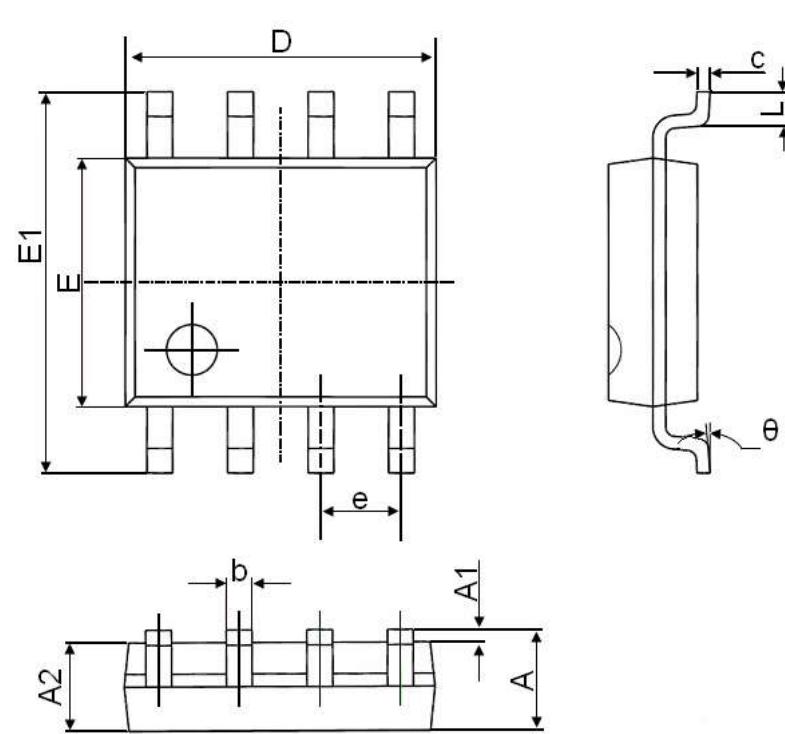


Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature



SOP-8 Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 1.350 | 1.750 | 0.053 | 0.069 |
| A1 | 0.100 | 0.250 | 0.004 | 0.010 |
| A2 | 1.350 | 1.550 | 0.053 | 0.061 |
| b | 0.330 | 0.510 | 0.013 | 0.020 |
| c | 0.170 | 0.250 | 0.006 | 0.010 |
| D | 4.700 | 5.100 | 0.185 | 0.200 |
| E | 3.800 | 4.000 | 0.150 | 0.157 |
| E1 | 5.800 | 6.200 | 0.228 | 0.244 |
| e | 1.270(BSC) | | 0.050(BSC) | |
| L | 0.400 | 1.270 | 0.016 | 0.050 |
| θ | 0° | 8° | 0° | 8° |

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